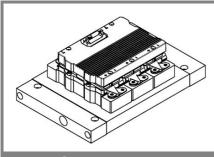
## SKiiP 1803GB172-3DW



SKiiP® 3

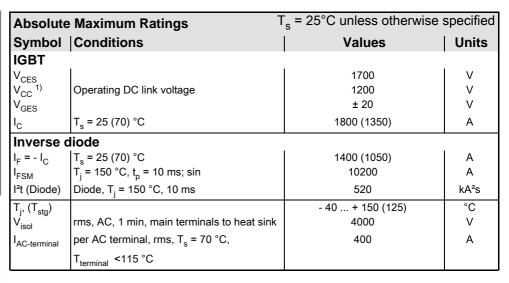
## 2-pack-integrated intelligent Power System

### Power section SKiiP 1803GB172-3DW

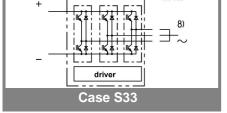
Data

#### **Power section features**

- SKiiP technology inside
- Trench IGBTs
- CAL diode technology
- · Integrated current sensor
- Integrated teperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP<sup>®</sup> 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- with assembly of suitable MKP capacitor per terminal
- 8) AC connection busbars must be connected by the user; copper busbars available on request

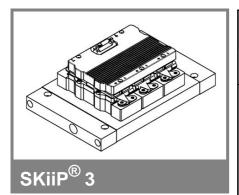


Characteristics				T <sub>s</sub> = 25°C unless otherwise specified					
Symbol	mbol  Conditions				min.	typ.	max.	Units	
IGBT									
V <sub>CEsat</sub>	$I_C = 900 \text{ A}, T_j = 25 (125) ^{\circ}\text{C};$ measured at terminal					1,9 (2,2)	2,4	٧	
$V_{CEO}$	$T_i = 25 (12)$	5) °C; at t	erminal			1 (0,9)	1,2 (1,1)	V	
$r_{CE}$	$T_{j} = 25 (12)$					1 (1,4) 3,6 (216)	1,3 (1,7)	mΩ	
I <sub>CES</sub>	$V_{GE} = 0 \text{ V}, V_{CE} = V_{CES},$ $T_{i} = 25 (125) ^{\circ}\text{C}$					mA			
$E_{on} + E_{off}$	$I_{\rm C} = 900  \text{A},  V_{\rm CC} = 900  \text{V}$					mJ			
	T <sub>j</sub> = 125 °C	T <sub>j</sub> = 125 °C, V <sub>CC</sub> = 1200 V				863			
R <sub>CC+EE</sub>	terminal ch	ip, T <sub>i</sub> = 25	5 °C		0,17			mΩ	
L <sub>CE</sub>	top, bottom	1			4			nΗ	
C <sub>CHC</sub>	per phase, AC-side				3			nF	
Inverse o	Inverse diode								
$V_F = V_{EC}$	I <sub>F</sub> = 900 A, measured at to	T <sub>j</sub> = 25 ( <i>*</i> erminal	125) °C			2 (1,8)	2,15	V	
$V_{TO}$	T <sub>i</sub> = 25 (12	5) °C				1,1 (0,8)	1,2 (0,9)	V	
r <sub>T</sub>	$T_i = 25 (125) ^{\circ}C$					1 (1,1)	1,1 (1,2)	mΩ	
Ė <sub>rr</sub>	$I_{\rm C} = 900  \text{A},  V_{\rm CC} = 900  \text{V}$					108	, ,	mJ	
	T <sub>j</sub> = 125 °C, V <sub>CC</sub> = 1200 V					128		mJ	
Mechani	cal data								
$M_{dc}$	DC terminals, SI Units				6		8	Nm	
M <sub>ac</sub>	AC terminals, SI Units				13		15	Nm	
W	SKiiP® 3 System w/o heat sink					2,4		kg	
W	heat sink					5,2		kg	
						c); "s" ref			
	1	e to bui	it-in tem	perature	sensor	(acc.IEC			
R <sub>th(j-s)I</sub>	per IGBT						0,017	K/W	
R <sub>th(j-s)D</sub>	per diode					1-	0,033	K/W	
$Z_{th}$	R <sub>i</sub> (mK/W) (max. values) 1 2 3 4				tau <sub>i</sub> (s)			4	
7	1,4	2 6,8	3 7,8	0	69	2 0,35	0,02	4 1	
$Z_{th(j-r)l}$ $Z_{th(j-r)D}$	2,6	4	17,7	17,7	50	5	0,02	0,04	
$Z_{th(r-a)}$	4,6	4,7	1,1	0,6	48	15	2,8	0,4	
11(1-a)	1	•	*	•			-	•	



This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee, expressed or implied is made regarding delivery, performance or suitability.

## SKiiP 1803GB172-3DW



# 2-pack-integrated intelligent Power System

2-pack integrated gate driver SKiiP 1803GB172-3DW

Data

#### Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings	a = 25°C unless otherwise specified		
Symbol	Conditions	Values	Units	
$V_{S2}$	unstabilized 24 V power supply	30	V	
$V_{i}$	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
$V_{isollO}$	input / output (AC, rms, 2s)	4000	V	
V <sub>isoIPD</sub>	partial discharge extinction voltage, rms, Q <sub>PD</sub> ≤10 pC;	1500	V	
V <sub>isol12</sub>	output 1 / output 2 (AC, rms, 2s)	1500	V	
f <sub>sw</sub>	switching frequency	9	kHz	
f <sub>out</sub>	output frequency for I <sub>peak(1)</sub> =I <sub>C</sub>	9	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 <b>+</b> 85	°C	

Characte	eristics	(T <sub>a</sub> = 25°C			
Symbol	Conditions	min.	typ.	max.	Units
$V_{S2}$	supply voltage non stabilized	13	24	30	V
I <sub>S2</sub>	V <sub>S2</sub> = 24 V	380+34*f/kHz+0,00015*(I <sub>AC</sub> /A) <sup>2</sup>			mA
V <sub>iT+</sub>	input threshold voltage (High)			12,3	V
$V_{iT-}$	input threshold voltage (Low)	4,6			V
R <sub>IN</sub>	input resistance		10		kΩ
C <sub>IN</sub>	input capacitance		1		nF
t <sub>d(on)IO</sub>	input-output turn-on propagation time		1,3		μs
$t_{d(off)IO}$	input-output turn-off propagation time		1,3		μs
t <sub>pERRRESET</sub>	error memory reset time		9		μs
$t_{TD}$	top / bottom switch interlock time		3,3		μs
I <sub>analogOUT</sub>	max. 5mA; 8 V corresponds to 15 V supply		1500		Α
	voltage for external components				
I <sub>s1out</sub>	max. load current			50	mA
I <sub>TRIPSC</sub>	over current trip level				
	$(I_{analog} OUT = 10 V)$		1875		Α
$T_tp$	over temperature protection	110		120	°C
U <sub>DCTRIP</sub>	$U_{DC}$ -protection ( $U_{analog OUT} = 9 V$ );		not implemented	i	V
	(option for GB types)				

For electrical and thermal design support please use SEMISEL. Access to SEMISEL is via SEMIKRON website http://www.semikron.com.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee, expressed or implied is made regarding delivery, performance or suitability.

